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**Simulation Experts Across Industries to Share How Multiphysics Transformed Their Work at the COMSOL Conference 2018 Lausanne**

Learn how multiphysics modeling and simulation apps have transformed the power industry, food industry, process simulation, the acoustics- and beauty industries as well as the design optimization in academia at the COMSOL Conference in Lausanne.

**Bangalore:** Aug 9-10 | **Boston**: Oct 3-5 | **Lausanne**: Oct 22-24

**Shanghai:** Nov 1-2 | **Taipei**: Nov 9 | **Seoul**: Nov 23 | **Tokyo**: Dec 7

HELSINKI, FINLAND (June 27, 2018) –COMSOL, Inc. is pleased to announce this year’s keynote speakers at the COMSOL Conference 2018. The event, held in seven major cities, arrives in Lausanne on October 22-24 and features the following experts in multiphysics modeling and simulation apps:

* **Adrien Charmetant**, Nexans Research Center, electric power industry
* **Thijs Defraeye**, EMPA, Laboratory for Biomimetic Membranes and Textiles, drying of soft foods
* **Andri Bezzola**, Samsung Audio Lab, acoustics industry
* **Matt James**, GHD (Jemella Limited), beauty industry
* **Florian Klunker**, Huntsman Advanced Materials, process simulation
* **Mario Paolone and EPFLoop Team,** Swiss Federal Institute of Technology of Lausanne (EPFL), multiphysics design optimization of the Hyperloop Pod

More details about the keynote talks can be found at: [www.comsol.fi/conference/keynotes/lausanne](http://www.comsol.fi/conference/keynotes/lausanne)

**Lausanne Conference Highlights**

The COMSOL Conference brings the simulation community together around the world to discuss and exchange best practices around the use of mathematical modeling and numerical simulation. The event features many parallel sessions on structural mechanics, acoustics, electromagnetics, fluid flow, heat transfer, and chemical reactions. Program highlights include:

* Presentations and keynotes on product design and research by the COMSOL community
* 40+ minicourses and workshops on multiphysics simulation
* Panel discussions covering topics such as acoustics, power electromagnetics and additive manufacturing
* Announcing the latest simulation technology

For more information about the COMSOL Conference 2018 Lausanne, visit:

[www.comsol.fi/conference/lausanne](http://www.comsol.fi/conference/lausanne)

**About COMSOL**

COMSOL is a global provider of simulation software for product design and research to technical enterprises, research labs, and universities. Its COMSOL Multiphysics® product is an integrated software environment for creating physics-based models and simulation apps. A particular strength is its ability to account for coupled or multiphysics phenomena. Add-on products expand the simulation platform for electromagnetics, structural, acoustics, fluid flow, heat transfer, and chemical applications. Interfacing tools enable the integration of COMSOL Multiphysics® simulations with all major technical computing and CAD tools on the CAE market. Simulation experts rely on the COMSOL Server™ product to deploy apps to their design teams, manufacturing departments, test laboratories, and customers throughout the world. Founded in 1986, COMSOL employs more than 450 people in 19 offices worldwide and extends its reach with a network of distributors.

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